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1-28-03  
December 10, 2002  
2811

To: Commissioner of Patents and Trademarks  
Washington, D.C. 20231

Fr: Stephen B. Ackerman, Reg. No. 37,761  
28 Davis Ave.  
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 09/846,536

05/02/01

W. T. Chu et al

"SELF ALIGNED, LOW CONTACT RESISTANCE,  
VIA FABRICATION PROCESS"

GRP. Art. Unit 2811

O. Nadav

### RESPONSE PATENT OFFICE ACTION

Dear Sir;

In response to the Office Action dated October 16, 2002, please amend the identified  
application for patent as follows:

The commissioner is hereby authorized to charge payment of any additional fees involved  
with added Claims and the like to Deposit Account No. 19-0033

### CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal  
Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks,  
Washington, D.C. 20231, on January 8, 2003.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date

1/8/03

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JAN 15 2003  
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